

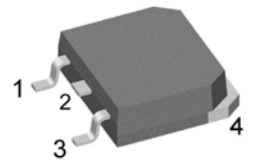
XPT IGBT

		preliminary
V_{CES}	=	1200V
I_{C25}	=	20A
$V_{CE(sat)}$	=	1.8V

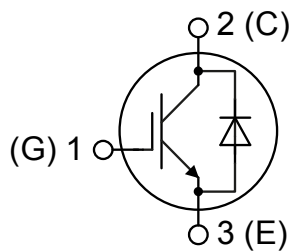
Copack

Part number

IXA12IF1200TC



Backside: collector



Features / Advantages:

- Easy paralleling due to the positive temperature coefficient of the on-state voltage
- Rugged XPT design (Xtreme light Punch Through) results in:
 - short circuit rated for 10 μ sec.
 - very low gate charge
 - low EMI
 - square RBSOA @ 3x Ic
- Thin wafer technology combined with the XPT design results in a competitive low $V_{CE(sat)}$
- SONIC™ diode
 - fast and soft reverse recovery
 - low operating forward voltage

Applications:

- AC motor drives
- Solar inverter
- Medical equipment
- Uninterruptible power supply
- Air-conditioning systems
- Welding equipment
- Switched-mode and resonant-mode power supplies
- Inductive heating, cookers
- Pumps, Fans

Package: TO-268AA (D3Pak)

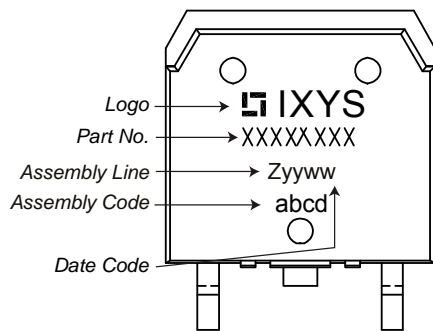
- Industry standard outline
- RoHS compliant
- Epoxy meets UL 94V-0

IGBT				Ratings					
Symbol	Definition	Conditions	min.	typ.	max.	Unit			
V_{CES}	collector emitter voltage	$T_{VJ} = 25^{\circ}\text{C}$			1200	V			
V_{GES}	max. DC gate voltage				± 20	V			
V_{GEM}	max. transient gate emitter voltage				± 30	V			
I_{C25}	collector current	$T_C = 25^{\circ}\text{C}$			20	A			
I_{C100}		$T_C = 100^{\circ}\text{C}$			13	A			
P_{tot}	total power dissipation	$T_C = 25^{\circ}\text{C}$			85	W			
$V_{CE(sat)}$	collector emitter saturation voltage	$I_C = 10\text{A}; V_{GE} = 15\text{V}$		1.8	2.1	V			
				2.1		V			
$V_{GE(th)}$	gate emitter threshold voltage	$I_C = 0.3\text{mA}; V_{GE} = V_{CE}$	5.4	5.9	6.5	V			
I_{CES}	collector emitter leakage current	$V_{CE} = V_{CES}; V_{GE} = 0\text{V}$			0.1	mA			
				0.1		mA			
I_{GES}	gate emitter leakage current	$V_{GE} = \pm 20\text{V}$			500	nA			
$Q_{G(on)}$	total gate charge	$V_{CE} = 600\text{V}; V_{GE} = 15\text{V}; I_C = 10\text{A}$		27		nC			
$t_{d(on)}$	turn-on delay time	inductive load $V_{CE} = 600\text{V}; I_C = 10\text{A}$ $V_{GE} = \pm 15\text{V}; R_G = 100\Omega$							
t_r	current rise time						$T_{VJ} = 125^{\circ}\text{C}$	70	ns
$t_{d(off)}$	turn-off delay time						40	ns	
t_f	current fall time						250	ns	
E_{on}	turn-on energy per pulse						100	ns	
E_{off}	turn-off energy per pulse						1.1	mJ	
		1.1	mJ						
RBSOA	reverse bias safe operating area	$V_{GE} = \pm 15\text{V}; R_G = 100\Omega$							
I_{CM}		$V_{CEmax} = 1200\text{V}$			30	A			
SCSOA	short circuit safe operating area	$V_{CEmax} = 900\text{V}$							
t_{sc}	short circuit duration	$V_{CE} = 900\text{V}; V_{GE} = \pm 15\text{V}$			10	μs			
I_{sc}	short circuit current	$R_G = 100\Omega; \text{non-repetitive}$			40	A			
R_{thJC}	thermal resistance junction to case				1.5	K/W			
R_{thCH}	thermal resistance case to heatsink			0.15		K/W			
Diode									
V_{RRM}	max. repetitive reverse voltage	$T_{VJ} = 25^{\circ}\text{C}$			1200	V			
I_{F25}	forward current	$T_C = 25^{\circ}\text{C}$			22	A			
I_{F100}		$T_C = 100^{\circ}\text{C}$			14	A			
V_F	forward voltage	$I_F = 10\text{A}$			2.20	V			
				1.95		V			
I_R	reverse current	$V_R = V_{RRM}$			*	mA			
	* not applicable, see Ices value above				*	mA			
Q_{rr}	reverse recovery charge	$V_R = 600\text{V}$ $-di_F/dt = -250\text{A}/\mu\text{s}$ $I_F = 10\text{A}; V_{GE} = 0\text{V}$							
I_{RM}	max. reverse recovery current						$T_{VJ} = 125^{\circ}\text{C}$	1.3	μC
t_{rr}	reverse recovery time						10.5	A	
E_{rec}	reverse recovery energy						350	ns	
				0.35		mJ			
R_{thJC}	thermal resistance junction to case				1.8	K/W			
R_{thCH}	thermal resistance case to heatsink			0.15		K/W			

preliminary

Package TO-268AA (D3Pak)			Ratings			
Symbol	Definition	Conditions	min.	typ.	max.	Unit
I_{RMS}	RMS current	per terminal			70	A
T_{VJ}	virtual junction temperature		-40		150	°C
T_{op}	operation temperature		-40		125	°C
T_{stg}	storage temperature		-40		150	°C
Weight				5		g
F_C	mounting force with clip		20		120	N

Product Marking



Part number

- I = IGBT
- X = XPT IGBT
- A = Gen 1 / std
- 12 = Current Rating [A]
- IF = Copack
- 1200 = Reverse Voltage [V]
- TC = TO-268AA (D3Pak) (2)

Ordering	Part Number	Marking on Product	Delivery Mode	Quantity	Code No.
Standard	IXA12IF1200TC	IXA12IF1200TC	Tube	30	508475

Similar Part	Package	Voltage class
IXA12IF1200HB	TO-247AD (3)	1200
IXA12IF1200PB	TO-220AB (3)	1200

Equivalent Circuits for Simulation

* on die level

$T_{VJ} = 150\text{ °C}$



	IGBT	Diode	
$V_{0\ max}$ threshold voltage	1.1	1.25	V
$R_{0\ max}$ slope resistance *	153	85	mΩ

IGBT

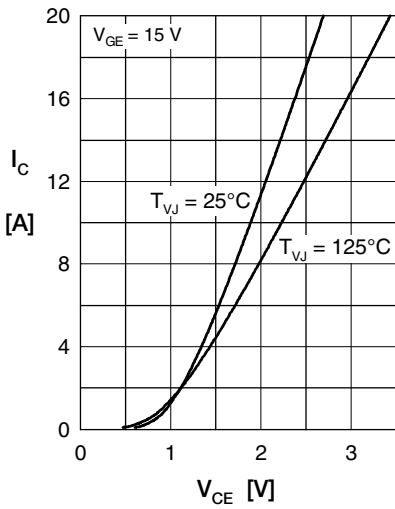


Fig. 1 Typ. output characteristics

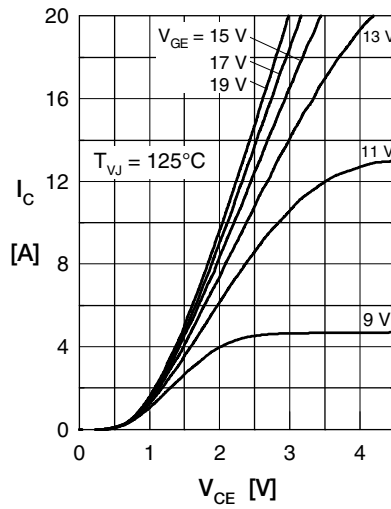


Fig. 2 Typ. output characteristics

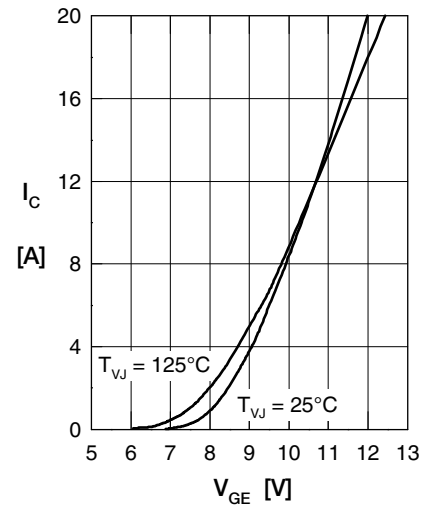


Fig. 3 Typ. transfer characteristics



Fig. 4 Typ. turn-on gate charge



Fig. 5 Typ. switching energy vs. collector current

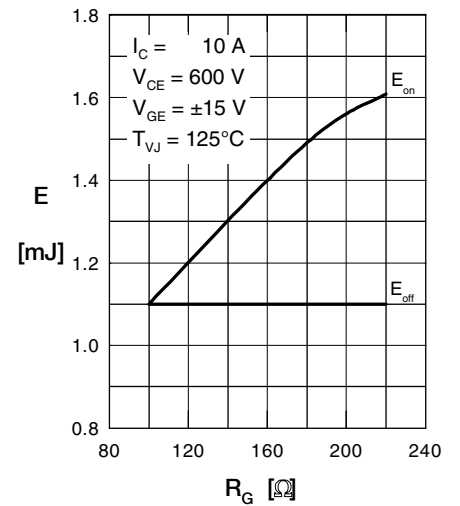


Fig. 6 Typ. switching energy vs. gate resistance

Fig. 7 Typ. transient thermal impedance junction to case

Diode

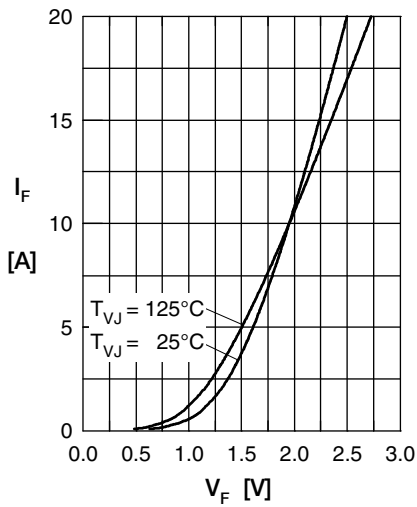


Fig. 1 Typ. forward current versus V_F

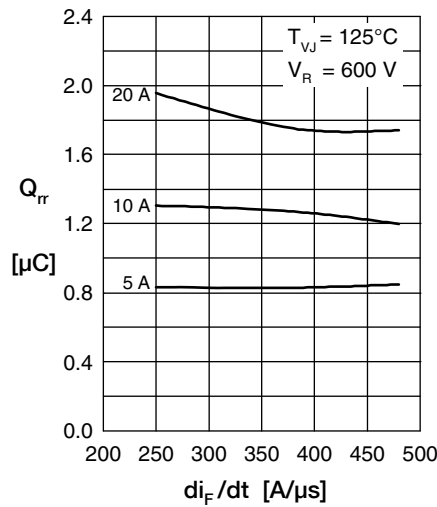


Fig. 2 Typical reverse recov. charge Q_{rr} versus di_F/dt

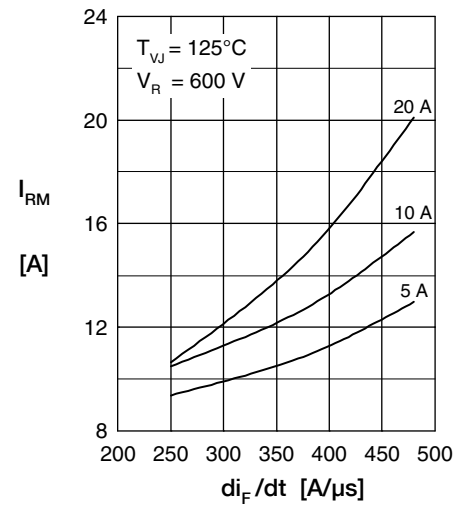


Fig.3 Typ: peak reverse current I_{RM} versus di_F/dt

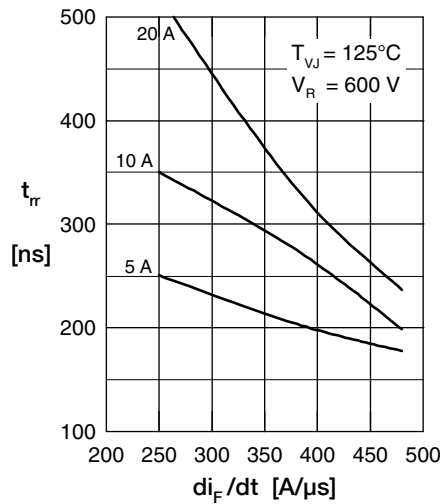


Fig. 4 Dynamic parameters Q_{rr} , I_{RM} versus T_{VJ}

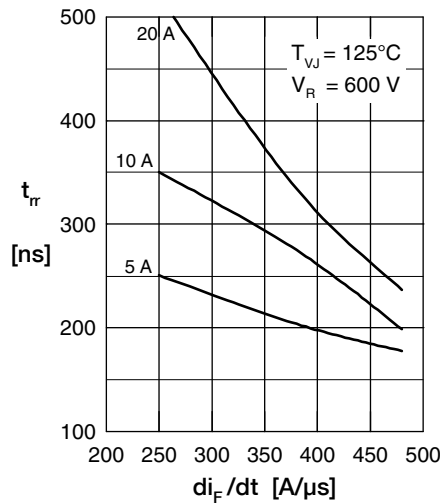


Fig. 5 Typ. recovery time t_{rr} versus di_F/dt

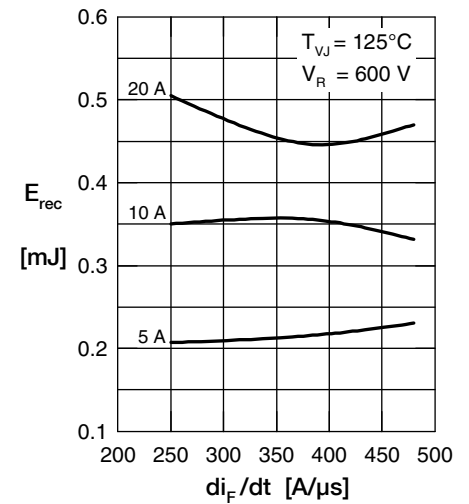


Fig. 6 Typ. recovery energy E_{rec} vs. di_F/dt

Fig. 7 Typ. transient thermal impedance junction to case



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